TE Internal #: 5-1393472-1

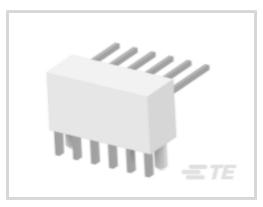
PCB Mount Header, Right Angle, Wire-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole -

Press-Fit, Natural

View on TE.com >

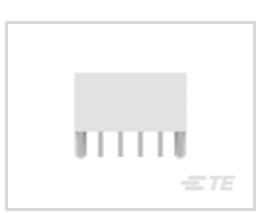


Connectors > PCB Connectors > PCB Headers & Receptacles > Low & Medium Power Header











Connector System: Wire-to-Board

Number of Positions: 6

Centerline (Pitch): 2.54 mm [.1 in]

Sealable: No

PCB Mount Orientation: Right Angle

All Low & Medium Power Header (143)

Features

Product Type Features

1 Toduct Type Teatures	
Mixed & Hybrid Header	No
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	6
PCB Mount Orientation	Right Angle
Number of Rows	1
Body Features	

Natural

Primary Product Color



Contact Type	Tab
Mating Tab Width	.63 mm[.025 in]
Mating Tab Thickness	.63 mm[.025 in]
Contact Mating Area Plating Material	Tin (Sn)
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
Mounting Holes	Without
Mating Alignment	With
PCB Mount Alignment	With
Panel Mount Feature	Without
PCB Mount Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Length	14.3 mm[.562 in]
Connector Width	5.5 mm[.216 in]
Profile Height from PCB	7.5 mm[.295 in]
Operation/Application	
Shielded	No
Packaging Features	
Packaging Type	Box

Product Compliance

Packaging Quantity

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)

1180



Candidate List Declared Against: JUNE
2023 (235)
Does not contain REACH SVHC
Low Halogen - Br, Cl, F, I < 900 ppm per
homogenous material. Also BFR/CFR/PVC

Free

Solder Process Capability

Halogen Content

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Customers Also Bought









Documents

Product Drawings
V23540B3606Z 11=6P. EINREIHIGE

English

PCB Mount Header, Right Angle, Wire-to-Board, 6 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Press-Fit, Natural



CAD Files

Customer View Model

ENG_CVM_CVM_5-1393472-1_A.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-1393472-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-1393472-1_A.3d_stp.zip

English

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